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To the Honorable Commissioner of Patents and Trademarks, U.S. Department of Commerce, Patent and Trademark Office, Washington, D.C. 20231
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4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

U.S.S.N. 09/297,320

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: George A. Loud

Internal Address: _____

Street Address: LORUSSO & LOUD

3137 Mt. Vernon Avenue

07/08/1999 PVL/PC 00000049 09297320
City: Alexandria State: VA ZIP: 22305

02 FC:581

40.00 DP

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

☒ Enclosed☐ Authorized to be charged to deposit account

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

George A. Loud

Name of Person Signing

Signature

02 JULY 1999

Date

Total number of pages including cover sheet, attachments, and document: 4

1. Names and addresses of conveying parties:

1. Akira SEKIYA of c/o National Institute of Materials and Chemical Research, 1, Higashi 1-chome, Tsukuba-shi, Ibaraki-ken, Japan
2. Tetsuya TAKAGAKI of c/o Electronic Industries Association of Japan, 2-2, Marunouchi 3-chome, Chiyoda-ku, Tokyo Japan
3. Shinsuke MORIKAWA of c/o Asahi Glass Co., Ltd., Research Center, 1150, Hazawacho, Kanagawa-ku, Yokohama-shi, Kanagawa-ken, Japan
4. Shunichi YAMASHITA of c/o Kanto Denka Kogyo Co., Ltd., 2-1, Marunouchi 1-chome, Chiyoda-ku, Tokyo, Japan
5. Tsuyoshi TAKAICHI of c/o Showa Denko K.K., 13-9, Shiba Daimon 1-chome, Minato-ku, Tokyo, Japan
6. Yasuo HIBINO of c/o Central Glass Co., Ltd., Chemical Research Center, 2805, Imafuku-Nakadai, Kawagoe-shi, Saitama-ken, Japan
7. Yasuhisa FURUTAKA of c/o Daikin Industries Ltd., Chemical Division, 1-1, Nishihitotsuya, Settsu-shi, Osaka, Japan
8. Masami IWASAKI of c/o Toagosei Co., Ltd., 14-1, Nishishimbashi 1-chome, Minato-ku, Tokyo, Japan
9. Norifumi OHTSUKA of c/o Du Pont-Mitsui Fluorochemicals Co., Ltd., 5-18, Sarugakucho 1-chome, Chiyoda-ku, Tokyo, Japan

2. Names and addresses of receiving parties:

1. DIRECTOR-GENERAL OF AGENCY OF INDUSTRIAL SCIENCE AND TECHNOLOGY of 3-1, kasumigaseki 1-chome, Chiyoda-ku, Tokyo, Japan
2. THE MECHANICAL SOCIAL SYSTEMS FOUNDATION of Mita Building, 4-28, Mita 1-chome, Minato-ku, Tokyo, Japan
3. ELECTRONIC INDUSTRIES ASSOCIATION OF JAPAN of 2-2, Marunouchi 3-chome, Chiyoda-ku, Tokyo, Japan
4. ASAHI GLASS CO., LTD. of 1-2, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan
5. DAIKIN INDUSTRIES, LTD. of Umeda Center Building, 4-12, Nakazaki-nishi 2-chome, Kita-ku, Osaka-shi, Osaka, Japan

Assignment

WHEREAS: The ASSIGNOR, comprising the following named inventor(s)

1. Akira SEKIYA of c/o National Institute of Materials and Chemical Research, 1, Higashi 1-chome, Tsukuba-shi, Ibaraki-ken, Japan
2. Tetsuya TAKAGAKI of c/o Electronic Industries Association of Japan, 2-2, Marunouchi 3-chome, Chiyoda-ku, Tokyo Japan
3. Shinsuke MORIKAWA of c/o Asahi Glass Co., Ltd., Research Center, 1150, Hazawacho, Kanagawa-ku, Yokohama-shi, Kanagawa-ken, Japan
4. Shunichi YAMASHITA of c/o Kanto Denka Kogyo Co., Ltd., 2-1, Marunouchi 1-chome, Chiyoda-ku, Tokyo, Japan
5. Tsuyoshi TAKAICHI of c/o Showa Denko K.K., 13-9, Shiba Daimon 1-chome, Minato-ku, Tokyo, Japan
6. Yasuo HIBINO of c/o Central Glass Co., Ltd., Chemical Research Center, 2805, Imafuku-Nakadai, Kawagoe-shi, Saitama-ken, Japan
7. Yasuhisa FURUTAKA of c/o Daikin Industries Ltd., Chemical Division, 1-1, Nishihitotsuya, Settsu-shi, Osaka, Japan
8. Masami IWASAKI of c/o Toagosei Co., Ltd., 14-1, Nishishimbashi 1-chome, Minato-ku, Tokyo, Japan
9. Norifumi OHTSUKA of c/o Du Pont-Mitsui Fluorochemicals Co., Ltd., 5-18, Sarugakucho 1-chome, Chiyoda-ku, Tokyo, Japan

has invented and owns a certain invention entitled:

DRY ETCHING GAS

for which application for Letters Patent of the United States Serial No. 09/297,320 was filed on April 29, 1999

and

WHEREAS, the ASSIGNEE

1. DIRECTOR-GENERAL OF AGENCY OF INDUSTRIAL SCIENCE AND TECHNOLOGY of 3-1, kasumigaseki 1-chome, Chiyoda-ku, Tokyo, Japan
2. THE MECHANICAL SOCIAL SYSTEMS FOUNDATION of Mita Building, 4-28, Mita 1-chome, Minato-ku, Tokyo, Japan

3. ELECTRONIC INDUSTRIES ASSOCIATION OF JAPAN of 2-2, Marunouchi 3-chome, Chiyoda-ku, Tokyo, Japan
4. ASAHI GLASS CO., LTD. of 1-2, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan
5. DAIKIN INDUSTRIES, LTD. of Umeda Center Building, 4-12, Nakazaki-nishi 2-chome, Kita-ku, Osaka-shi, Osaka, Japan

is desirous of acquiring the entire interest in, to and under said invention and the United States Letters Patent to be obtained therefor:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that in consideration of the payment by ASSIGNEE to ASSIGNOR of the sum corresponding to One Dollar(\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the full and exclusive right, title and interest to said invention and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute or reissue thereof for the full term or terms for which the same may be granted.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to ASSIGNOR, and will testify as to the same in any interference or litigation related thereto, and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.

IN WITNESS WHEREOF, the undersigned inventors have hereunto set
hand and seal this 17th day of June , 1999 .

1. Akira Sekiya
2. Tetsuya Takagaki
3. Shinsuke Prokawa
4. Shunichi Yamashita
5. Tsuyoshi Takaichi
6. Yasuo Hino
7. Yasuhisa Furutaka
8. Masami Iwasaki
9. Norifumi Ohtsuka